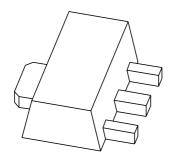
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4320X 20 V, 3 A NPN low V_{CEsat} (BISS) transistor

Product specification Supersedes data of 2003 Dec 15 2004 Nov 03





20 V, 3 A NPN low V_{CEsat} (BISS) transistor

PBSS4320X

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- · Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 plastic package. PNP complement: PBSS5320X.

MARKING

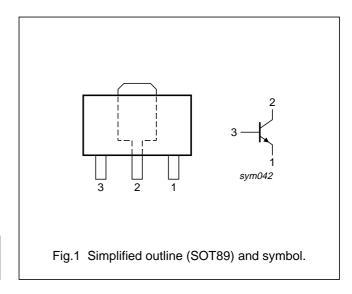
TYPE NUMBER	MARKING CODE
PBSS4320X	S44

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	20	V
I _C	collector current (DC)	3	Α
I _{CM}	peak collector current	5	Α
R _{CEsat}	equivalent on-resistance	105	mΩ

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	



ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
I II E NOMBER	NAME DESCRIPTION		VERSION	
PBSS4320X	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads		SOT89	

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

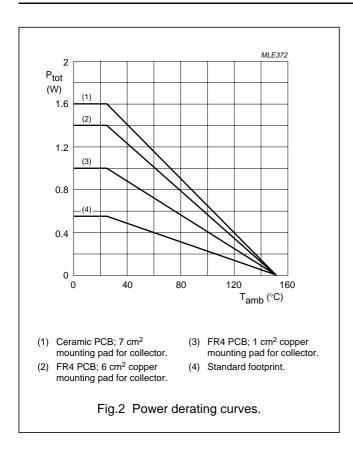
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CEO}	collector-emitter voltage	open base	_	20	V
V _{EBO}	emitter-base voltage	open collector	_	5	٧
I _C	collector current (DC)	note 4	_	3	Α
I _{CM}	peak collector current	limited by T _{j(max)}	_	5	Α
I _B	base current (DC)		_	0.5	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		note 1	_	550	mW
		note 2	_	1	W
		note 3	_	1.4	W
		note 4	_	1.6	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².
- 4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.

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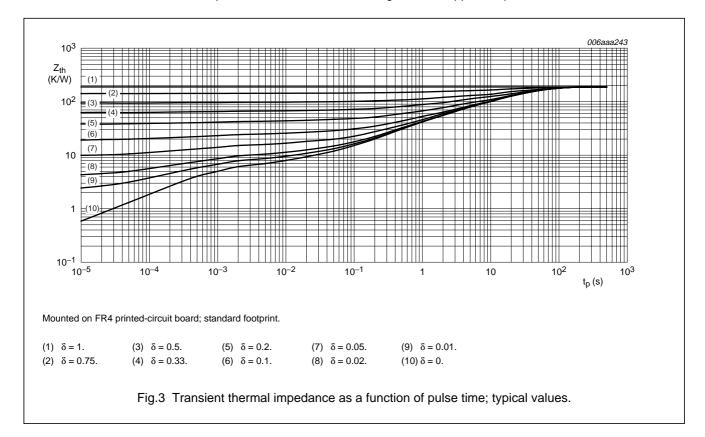
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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
		note 3	90	K/W
		note 4	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

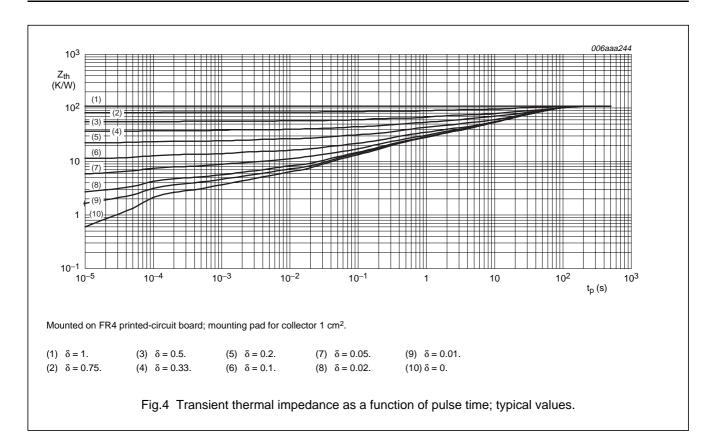
Notes

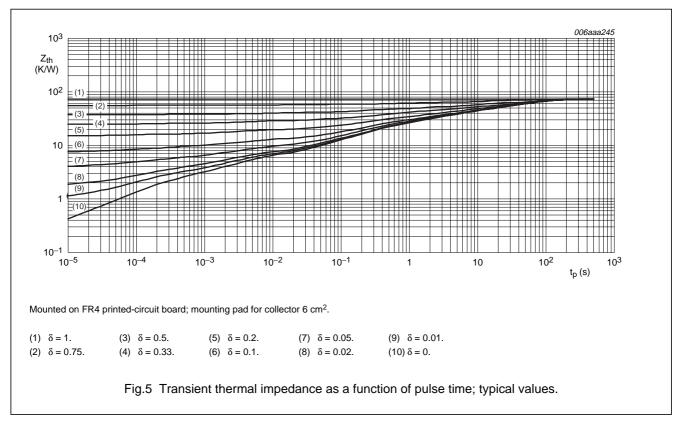
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- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².
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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

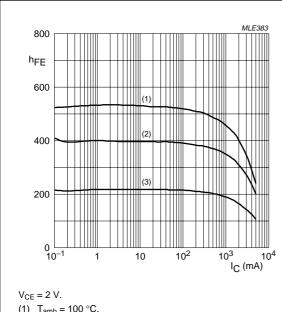
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 20 V; I _E = 0 A	-	-	100	nA
		V _{CB} = 20 V; I _E = 0 A; T _j = 150 °C	_	_	50	μΑ
I _{CES}	collector-emitter cut-off current	V _{CE} = 20 V; V _{BE} = 0 V	_	_	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V				
		I _C = 0.1 A	220	-	_	
		I _C = 0.5 A	220	-	_	
		I _C = 1 A; note 1	220	-	_	
		I _C = 2 A; note 1	200	-	_	
		I _C = 3 A; note 1	150	-	_	
V _{CEsat}	collector-emitter saturation	I _C = 0.5 A; I _B = 50 mA	_	_	70	mV
	voltage	I _C = 1 A; I _B = 50 mA	_	_	120	mV
		I _C = 2 A; I _B = 100 mA	_	_	240	mV
		I _C = 3 A; I _B = 300 mA; note 1	_	_	310	mV
R _{CEsat}	equivalent on-resistance	I _C = 3 A; I _B = 300 mA; note 1	_	85	105	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 2 A; I _B = 100 mA	_	1.1	_	V
		I _C = 3 A; I _B = 300 mA; note 1	_	_	1.2	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C = 1 A	1.1	_	_	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 5 V; f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	_	35	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

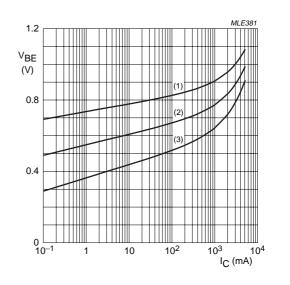
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- (1) T_{amb} = 100 °C.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

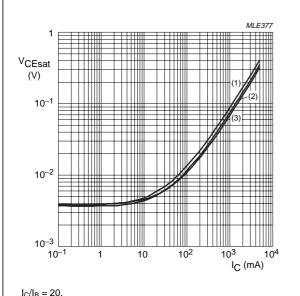
Fig.6 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

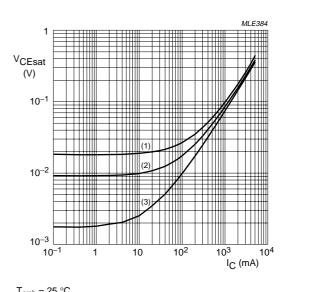
Fig.7 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) T_{amb} = 100 °C.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



 $T_{amb} = 25 \, ^{\circ}C.$

- (1) $I_C/I_B = 100$.
- (2) $I_C/I_B = 50$.
- (3) $I_C/I_B = 10$.

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

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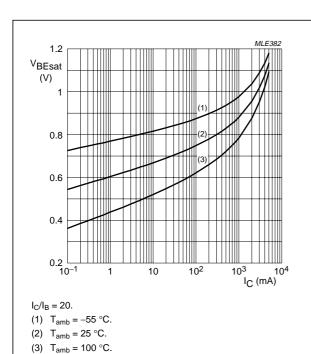


Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.

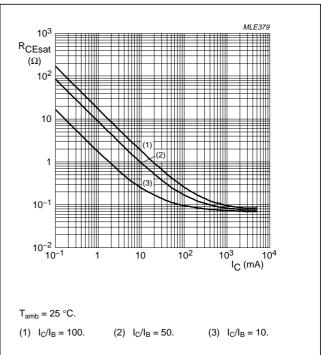


Fig.11 Equivalent on-resistance as a function of collector current; typical values.

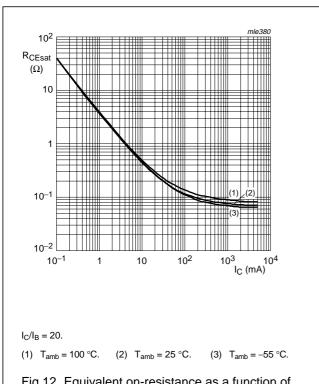
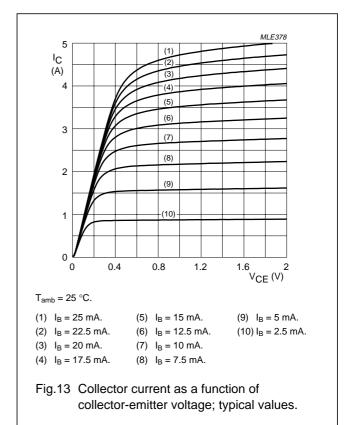


Fig.12 Equivalent on-resistance as a function of collector current; typical values.



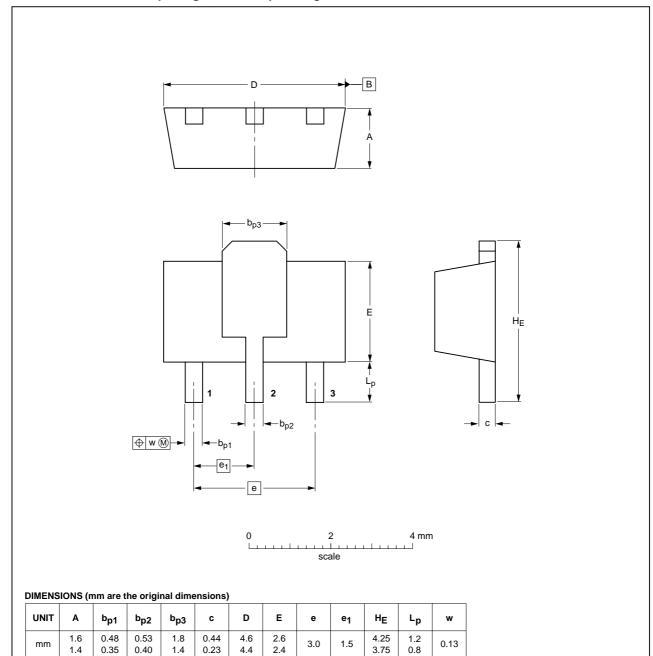
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION 1550E DA	
SOT89		TO-243	SC-62			99-09-13 04-08-03

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DATA SHEET STATUS

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I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R75/03/pp12

Date of release: 2004 Nov 03

Document order number: 9397 750 13881

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